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May 2014



# FGB3440G2\_F085 / FGD3440G2\_F085 FGP3440G2\_F085

## EcoSPARK<sup>®</sup> 2 335mJ, 400V, N-Channel Ignition IGBT

### Features

- SCIS Energy = 335mJ at  $T_J = 25^\circ\text{C}$
- Logic Level Gate Drive
- Qualified to AEC Q101
- RoHS Compliant

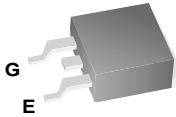
### Applications

- Automotive Ignition Coil Driver Circuits
- Coil On Plug Applications

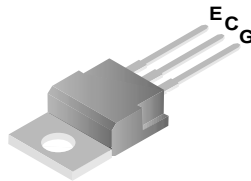


### Package

JEDEC TO-263AB  
D<sup>2</sup>-Pak



JEDEC TO-220AB

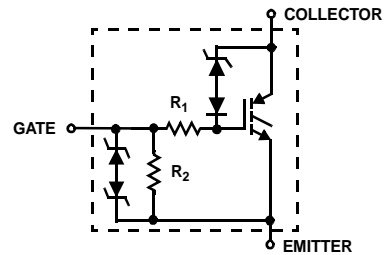


JEDEC TO-252AA  
D-Pak



COLLECTOR  
(FLANGE)

### Symbol



### Device Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
$BV_{CER}$	Collector to Emitter Breakdown Voltage ( $I_C = 1\text{mA}$ )	400	V
$BV_{ECS}$	Emitter to Collector Voltage - Reverse Battery Condition ( $I_C = 10\text{mA}$ )	28	V
$E_{SCIS25}$	Self Clamping Inductive Switching Energy (Note 1)	335	mJ
$E_{SCIS150}$	Self Clamping Inductive Switching Energy (Note 2)	195	mJ
$I_{C25}$	Collector Current Continuous, at $V_{GE} = 4.0\text{V}$ , $T_C = 25^\circ\text{C}$	26.9	A
$I_{C110}$	Collector Current Continuous, at $V_{GE} = 4.0\text{V}$ , $T_C = 110^\circ\text{C}$	25	A
$V_{GEM}$	Gate to Emitter Voltage Continuous	$\pm 10$	V
$P_D$	Power Dissipation Total, at $T_C = 25^\circ\text{C}$	166	W
	Power Dissipation Derating, for $T_C > 25^\circ\text{C}$	1.1	W/ $^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-40 to +175	$^\circ\text{C}$
$T_{STG}$	Storage Junction Temperature Range	-40 to +175	$^\circ\text{C}$
$T_L$	Max. Lead Temp. for Soldering (Leads at 1.6mm from case for 10s)	300	$^\circ\text{C}$
$T_{PKG}$	Max. Lead Temp. for Soldering (Package Body for 10s)	260	$^\circ\text{C}$
ESD	Electrostatic Discharge Voltage at 100pF, 1500 $\Omega$	4	kV

FGB3440G2\_F085 / FGD3440G2\_F085 / FGP3440G2\_F085

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGB3440G2	FGB3440G2_F085	TO-263AB	330mm	24mm	800
FGD3440G2	FGD3440G2_F085	TO-252AA	330mm	16mm	2500
FGP3440G2	FGP3440G2_F085	TO-220AB	Tube	N/A	50

## Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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### Off State Characteristics

$BV_{CER}$	Collector to Emitter Breakdown Voltage	$I_{CE} = 2\text{mA}, V_{GE} = 0,$ $R_{GE} = 1\text{K}\Omega,$ $T_J = -40 \text{ to } 150^\circ\text{C}$	370	400	430	V	
$BV_{CES}$	Collector to Emitter Breakdown Voltage	$I_{CE} = 10\text{mA}, V_{GE} = 0V,$ $R_{GE} = 0,$ $T_J = -40 \text{ to } 150^\circ\text{C}$	390	420	450	V	
$BV_{ECS}$	Emitter to Collector Breakdown Voltage	$I_{CE} = -20\text{mA}, V_{GE} = 0V,$ $T_J = 25^\circ\text{C}$	28	-	-	V	
$BV_{GES}$	Gate to Emitter Breakdown Voltage	$I_{GES} = \pm 2\text{mA}$	$\pm 12$	$\pm 14$	-	V	
$I_{CER}$	Collector to Emitter Leakage Current	$V_{CE} = 250V, R_{GE}=1\text{K}\Omega$	$T_J = 25^\circ\text{C}$	-	-	25	$\mu\text{A}$
			$T_J = 150^\circ\text{C}$	-	-	1	mA
$I_{ECS}$	Emitter to Collector Leakage Current	$V_{EC} = 24V,$	$T_J = 25^\circ\text{C}$	-	-	1	mA
			$T_J = 150^\circ\text{C}$	-	-	40	
$R_1$	Series Gate Resistance		-	120	-	$\Omega$	
$R_2$	Gate to Emitter Resistance		10K	-	30K	$\Omega$	

### On State Characteristics

$V_{CE(SAT)}$	Collector to Emitter Saturation Voltage	$I_{CE} = 6A, V_{GE} = 4V,$	$T_J = 25^\circ\text{C}$	-	1.1	1.2	V
$V_{CE(SAT)}$	Collector to Emitter Saturation Voltage	$I_{CE} = 10A, V_{GE} = 4.5V,$	$T_J = 150^\circ\text{C}$	-	1.3	1.45	V
$V_{CE(SAT)}$	Collector to Emitter Saturation Voltage	$I_{CE} = 15A, V_{GE} = 4.5V,$	$T_J = 150^\circ\text{C}$	-	1.6	1.75	V
$E_{SCIS}$	Self Clamped Inductive Switching	$L = 3.0 \text{ mHy}, V_{GE} = 5V$ $R_G = 1\text{K}\Omega, (\text{Note } 1)$	$T_J = 25^\circ\text{C}$	-	-	335	mJ

### Notes:

- 1: Self Clamping Inductive Switching Energy ( $E_{SCIS25}$ ) of 335mJ is based on the test conditions that is starting  $T_J=25^\circ\text{C}$ ;  $L=3\text{mHy}$ ,  $I_{SCIS}=15A$ ,  $V_{CC}=100V$  during inductor charging and  $V_{CC}=0V$  during the time in clamp.
- 2: Self Clamping Inductive Switching Energy ( $E_{SCIS150}$ ) of 195mJ is based on the test conditions that is starting  $T_J=150^\circ\text{C}$ ;  $L=3\text{mHy}$ ,  $I_{SCIS}=11.4A$ ,  $V_{CC}=100V$  during inductor charging and  $V_{CC}=0V$  during the time in clamp.

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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**Dynamic Characteristics**

$Q_{G(ON)}$	Gate Charge	$I_{CE} = 10\text{A}, V_{CE} = 12\text{V}, V_{GE} = 5\text{V}$	-	24	-	nC
$V_{GE(TH)}$	Gate to Emitter Threshold Voltage	$I_{CE} = 1\text{mA}, V_{CE} = V_{GE}, T_J = 25^\circ\text{C}$	1.3	1.7	2.2	V
		$T_J = 150^\circ\text{C}$	0.75	1.2	1.8	V
$V_{GEP}$	Gate to Emitter Plateau Voltage	$V_{CE} = 12\text{V}, I_{CE} = 10\text{A}$	-	2.8	-	V

**Switching Characteristics**

$t_{d(ON)R}$	Current Turn-On Delay Time-Resistive	$V_{CE} = 14\text{V}, R_L = 1\Omega$	-	1.0	4	$\mu\text{s}$
$t_{rR}$	Current Rise Time-Resistive	$V_{GE} = 5\text{V}, R_G = 1\text{K}\Omega, T_J = 25^\circ\text{C}$	-	2.0	7	$\mu\text{s}$
$t_{d(OFF)L}$	Current Turn-Off Delay Time-Inductive	$V_{CE} = 300\text{V}, L = 1\text{mH}, V_{GE} = 5\text{V}, R_G = 1\text{K}\Omega$	-	5.3	15	$\mu\text{s}$
$t_{fL}$	Current Fall Time-Inductive	$I_{CE} = 6.5\text{A}, T_J = 25^\circ\text{C}$	-	2.3	15	$\mu\text{s}$

**Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance Junction to Case		-	-	0.9	$^\circ\text{C/W}$
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### Typical Performance Curves

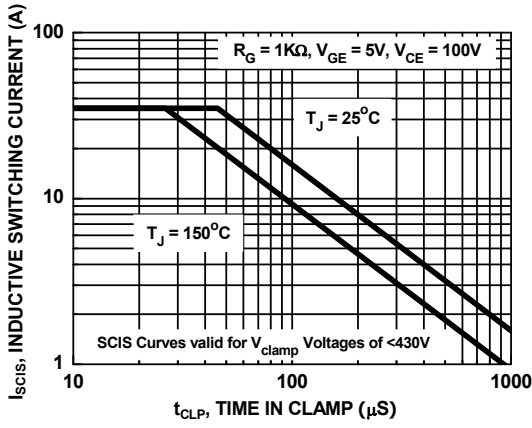


Figure 1. Self Clamped Inductive Switching Current vs. Time in Clamp

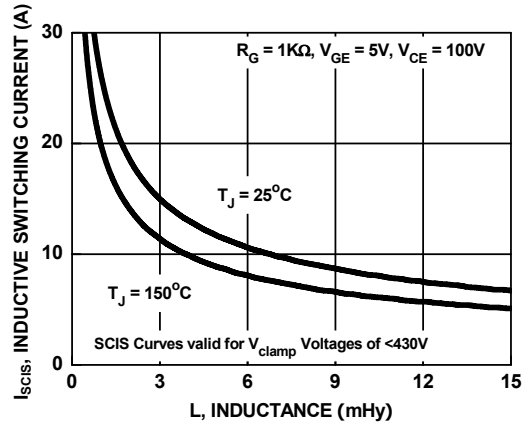


Figure 2. Self Clamped Inductive Switching Current vs. Inductance

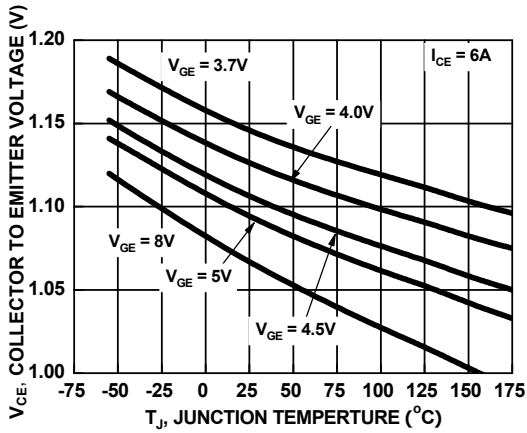


Figure 3. Collector to Emitter On-State Voltage vs. Junction Temperature

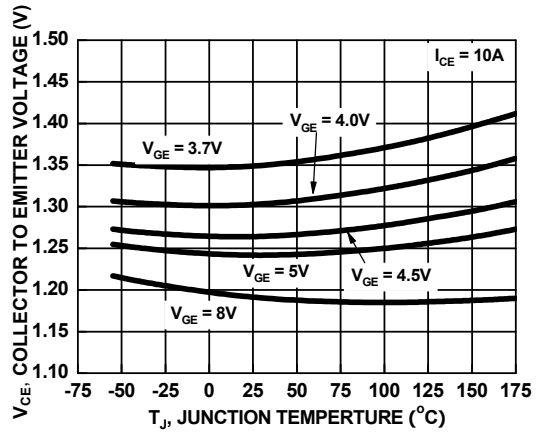


Figure 4. Collector to Emitter On-State Voltage vs. Junction Temperature

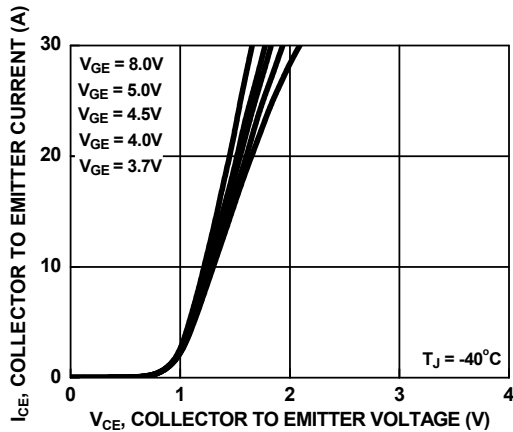


Figure 5. Collector to Emitter On-State Voltage vs. Collector Current

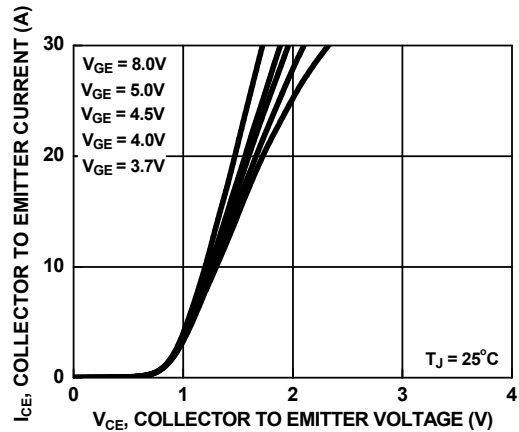
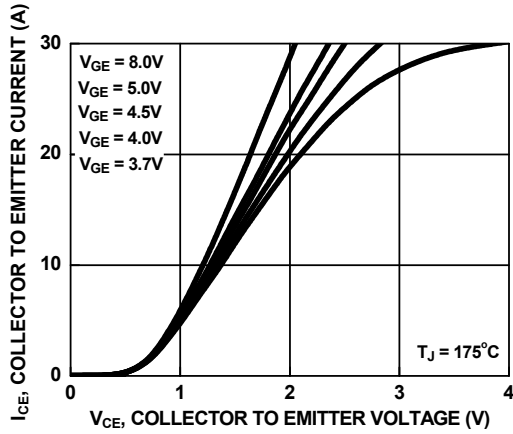
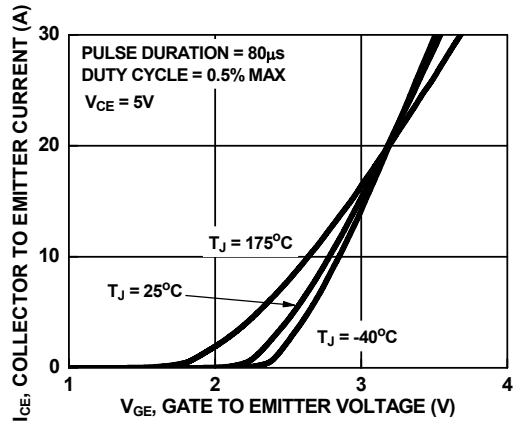


Figure 6. Collector to Emitter On-State Voltage vs. Collector Current

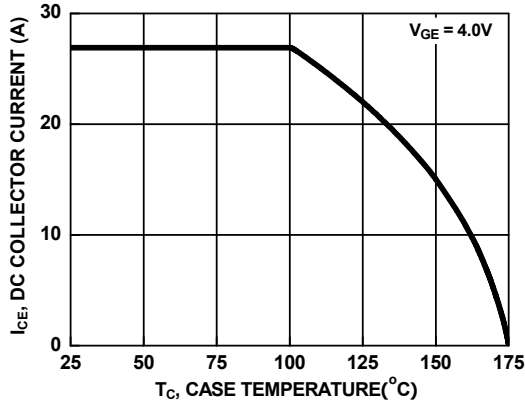
**Typical Performance Curves** (Continued)



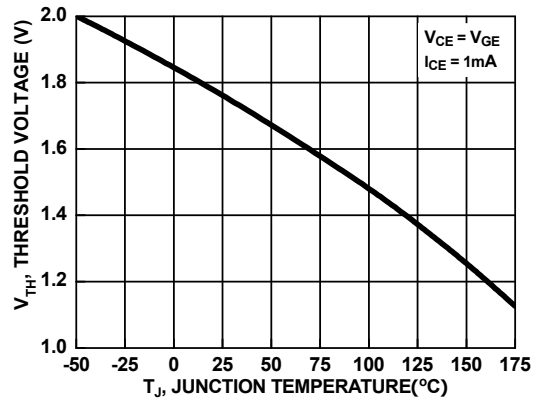
**Figure 7. Collector to Emitter On-State Voltage vs. Collector Current**



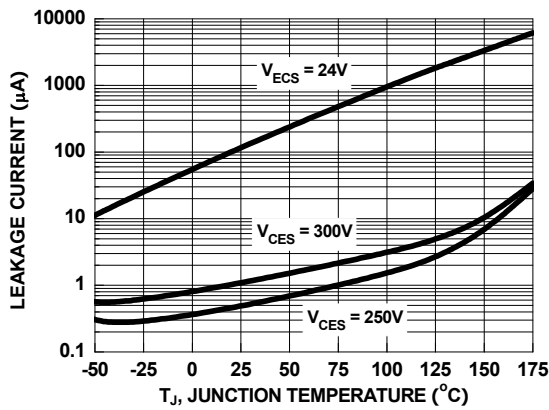
**Figure 8. Transfer Characteristics**



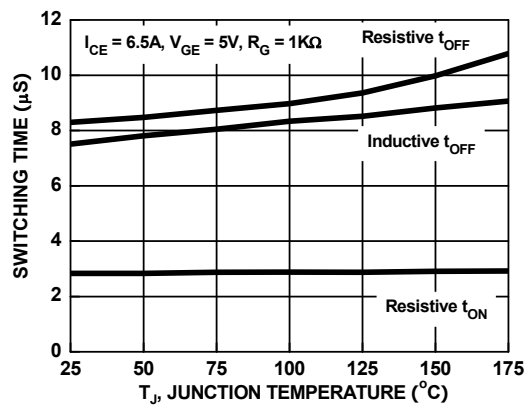
**Figure 9. DC Collector Current vs. Case Temperature**



**Figure 10. Threshold Voltage vs. Junction Temperature**

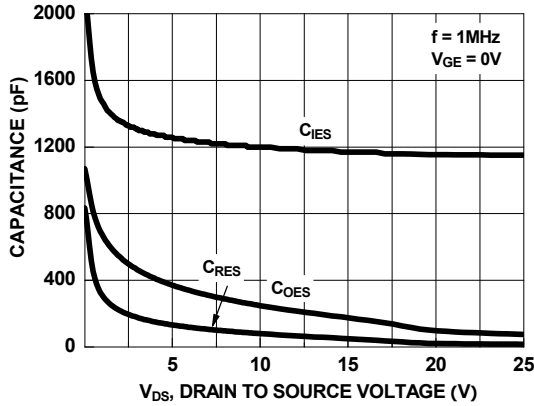


**Figure 11. Leakage Current vs. Junction Temperature**

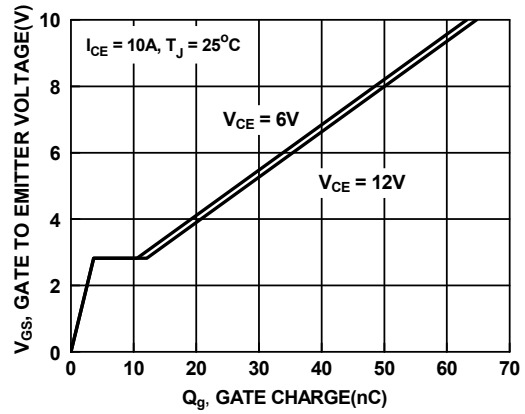


**Figure 12. Switching Time vs. Junction Temperature**

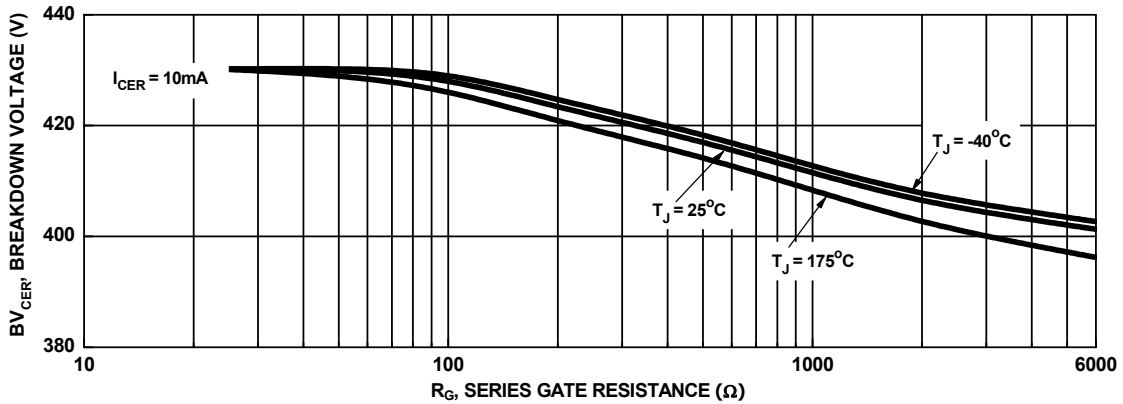
**Typical Performance Curves** (Continued)



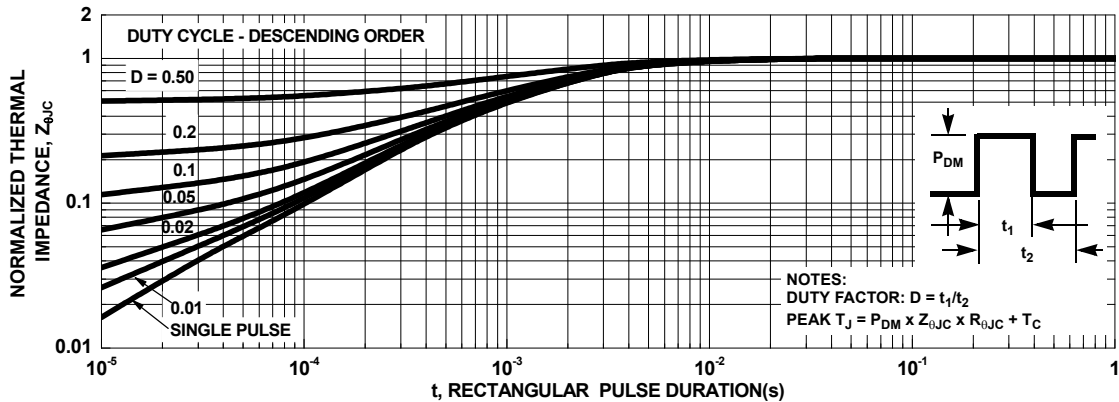
**Figure 13. Capacitance vs. Collector to Emitter Voltage**



**Figure 14. Gate Charge**

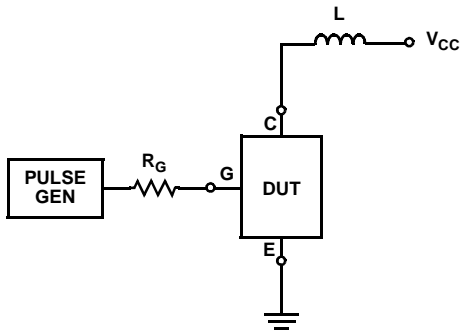


**Figure 15. Break down Voltage vs. Series Gate Resistance**

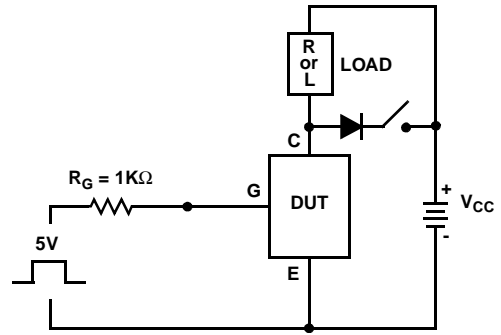


**Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case**

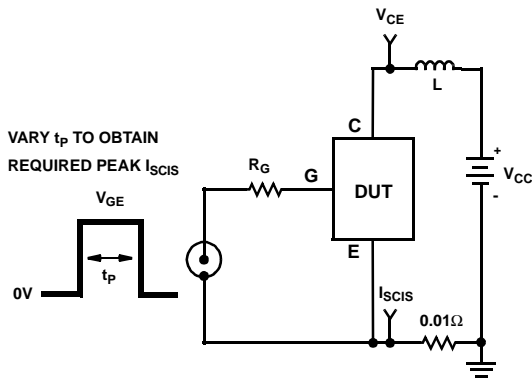
**Test Circuit and Waveforms**



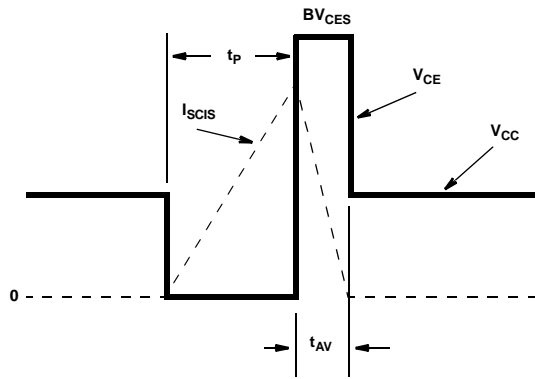
**Figure 17. Inductive Switching Test Circuit**



**Figure 18.  $t_{ON}$  and  $t_{OFF}$  Switching Test Circuit**



**Figure 19. Energy Test Circuit**








**Figure 20. Energy Waveforms**





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[FGP3440G2\\_F085](#)

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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